TOSHIBA Transistor Silicon NPN Epitaxial Planar Type (PCT process)

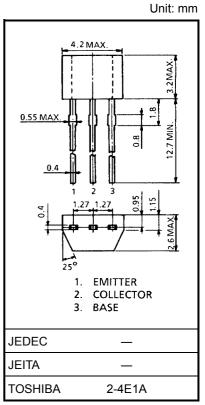
# 2SC2668

High Frequency Amplifier Applications FM, RF, IF Amplifier Applications

- Small reverse transfer capacitance:  $C_{re} = 0.70 \text{ pF (typ.)}$
- Low noise figure: NF = 2.5dB (typ.)

#### Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	40	V
Collector-emitter voltage	V <sub>CEO</sub>	30	V
Emitter-base voltage	V <sub>EBO</sub>	4	V
Collector current	IC	20	mA
Emitter current	Ι <sub>Β</sub>	4	mA
Collector power dissipation	PC	100	mW
Junction temperature range	Tj	125	°C
Storage temperature range	T <sub>stg</sub>	<b>−55~125</b>	°C



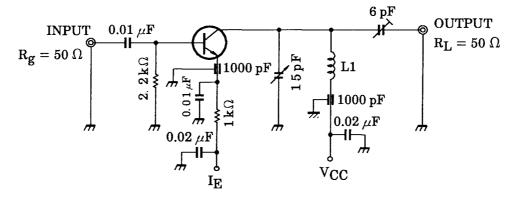
Weight: 0.13 g (typ.)

### **Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 40 \text{ V}, I_{E} = 0$	_	_	0.5	μА
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4 V, I <sub>C</sub> = 0	_	_	0.5	μΑ
DC current gain	h <sub>FE</sub> (Note)	V <sub>CE</sub> = 6 V, I <sub>C</sub> = 1 mA	40	_	200	
Reverse transfer capacitance	C <sub>re</sub>	V <sub>CE</sub> = 6 V, f = 1 MHz	_	0.70	_	pF
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 6 V, I <sub>C</sub> = 1 mA	_	550	_	MHz
Collector-base time constant	C <sub>c</sub> ⋅r <sub>bb′</sub>	$V_{CE} = 6 \text{ V}, I_{E} = -1 \text{ mA}, f = 30 \text{ MHz}$	_	_	30	ps
Noise figure	NF	V <sub>CC</sub> = 6 V, I <sub>E</sub> = -1 mA, f = 100 MHz,	_	2.5	5.0	dB
Power gain	G <sub>pe</sub>	(Figure 1)	—	18	_	dB

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Note: hFE classification R: 40~80 O: 70~140 Y: 100~200



 $L_1{:}~0.8~\text{mm}\phi$  silver plated copper wire, 4 turns. 10 mm ID, 8 mm length.

Figure 1 NF, Gpe Test Circuit

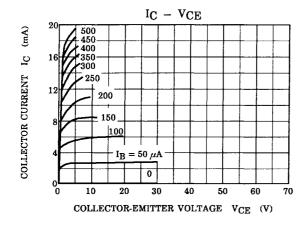
## Y Parameter (typ.)

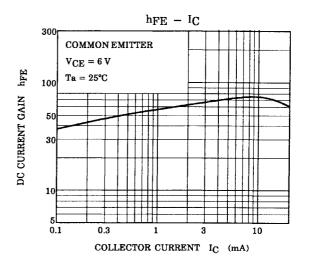
(1) Common emitter (VCE = 6 V, IE = -1 mA, f = 100 MHz)

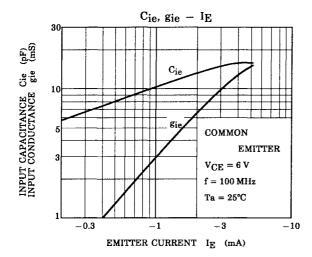
Characteristics	Symbol	Тур.	Unit
Input conductance	9ie	2.9	ms
Input capacitance	C <sub>ie</sub>	10.2	pF
Reverse transfer admittance	Y <sub>re</sub>	0.33	ms
Phase angle of reverse transfer admittance	$\theta_{\sf re}$	-90	0
Forward transfer admittance	Y <sub>fe</sub>	40	ms
Phase angle of forward transfer admittance	$\theta_{\sf fe}$	-20	o
Output conductance	9oe	45	μS
Output capacitance	C <sub>oe</sub>	1.1	pF

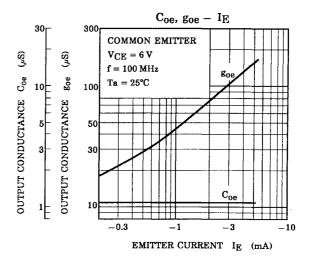
(2) Common base ( $V_{CB} = 6 \text{ V}, I_{E} = -1 \text{ mA}, f = 100 \text{ MHz}$ )

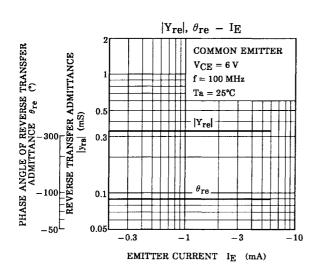
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Characteristics	Symbol	Тур.	Unit
Input conductance	gib	34	ms
Input capacitance	C <sub>ib</sub>	-10	pF
Reverse transfer admittance	Y <sub>rb</sub>	0.27	ms
Phase angle of reverse transfer admittance	$\theta_{\sf rb}$	-105	o
Forward transfer admittance	Y <sub>fb</sub>	34	ms
Phase angle of forward transfer admittance	$\theta_{fb}$	165	0
Output conductance	9 <sub>ob</sub>	45	μS
Output capacitance	C <sub>ob</sub>	1.1	pF



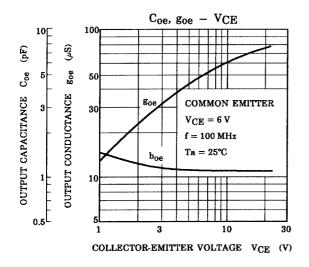


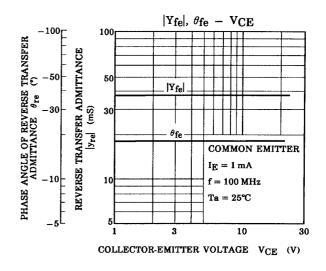


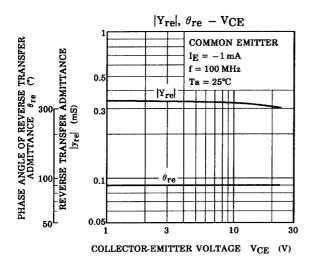


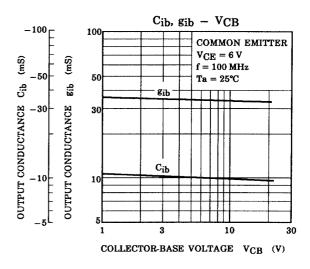


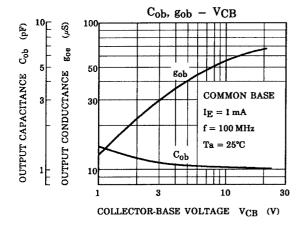
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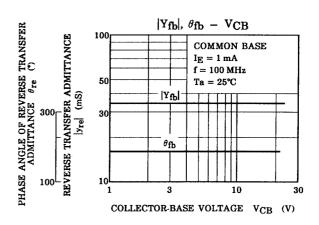




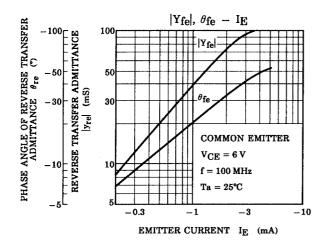


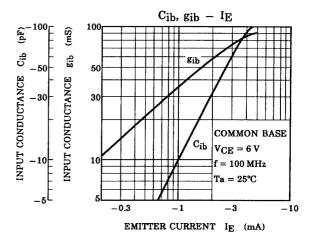


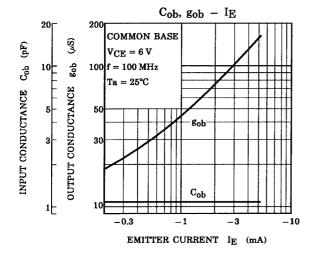


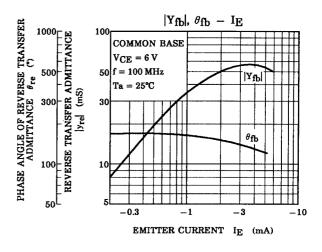


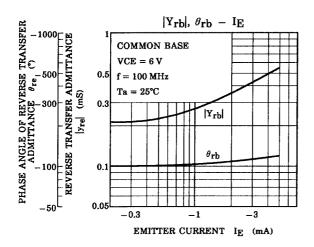
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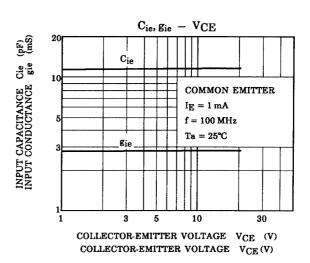




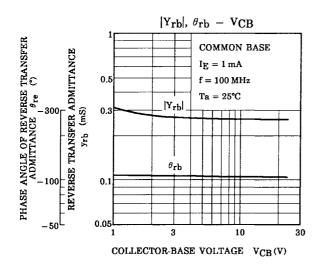


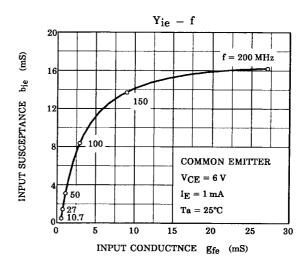


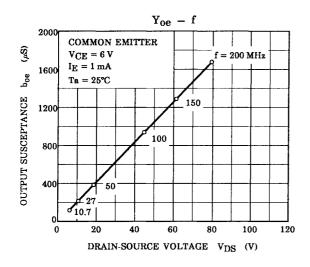


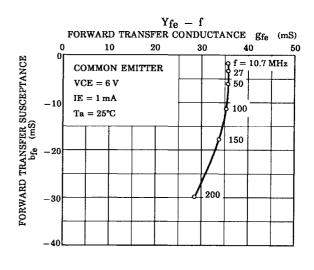


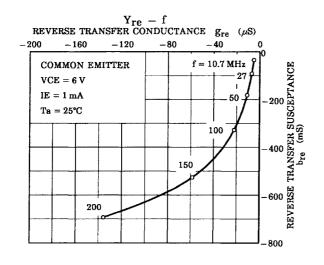
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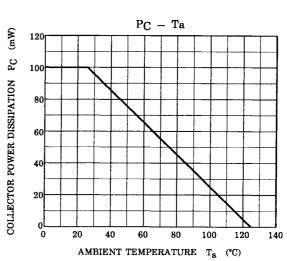












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